

Distribution	Ärende/Item	Datum/Date	Reg.nr/Reg.No.	Rev	Sida/Page
Art. No. 3643-0205	Reliability Prediction Report LynxDSS_L208-F2G-S2	2013-04-04		0	1(1)
Utfärdad av/Issued by				Godk.	
Lars Andersson					

LynxDSS_L208-F2G-S2 Reliability Prediction Data

Environment	MTBF 25°C [hours]	MTBF 40°C [hours]
GB	517 377	503 823

Device predicted

5011-1060-B-01 LynxDSS Power 4-layer
5011-1150-B-03 LynxPlus serial switch

Prediction Method

MIL-C217F2, Parts count.

Quality levels

Component type	Quality level
Passive R,C	R
Inductive	MIL
Connectors	MIL
Discrete semiconductors	JANTX
Microcircuits (IC)	Toolkit ¹

¹Toolkit, i.e. reliability prediction based on FIT (Failure In Time) values obtained from IC manufacturer. FIT values are used according to ROME LABORATORY RELIABILITY ENGINEER'S TOOLKIT, Temperature Conversion Factors (Table A11-3). FIT = 15 might be used until manufacturer data is obtained.

Environment

GB, Ground Benign

Enclosure

MTBF Pareto Report, Components contribution to total Failure Rate (>1%).